

EVLYS LTD. - POWER SEMICONDUCTORS DEVICES -

Wholesale and Retail.

Fast Thyristor Type FDT56-1000-28

Low switching losses / Low reverse recovery charge

Distributed amplified gate for high di_T/dt

Mean on-state current	I_{TAV}	1000 A			
Repetitive peak off-state voltage	V_{DRM}				
Repetitive peak reverse voltage	V_{RRM}	2000...2800 V			
Turn-off time	t_q	50.0, 63.0 μs			
V_{DRM}, V_{RRM}, V	2000	2200	2400	2600	2800
Voltage code	20	22	24	26	28
$T_j, ^\circ C$	-60...+125				

MAXIMUM ALLOWABLE RATINGS

Symbols and parameters		Units	Values	Test conditions	
ON-STATE					
I_{TAV}	Mean on-state current	A	906 1000 1347	$T_c = 85^\circ C$; Double side cooled; $T_c = 79^\circ C$; Double side cooled; $T_c = 55^\circ C$; Double side cooled; 180° half-sine wave; 50 Hz	
I_{TRMS}	RMS on-state current	A	1570	$T_c = 79^\circ C$; Double side cooled; 180° half-sine wave; 50 Hz	
I_{TSM}	Surge on-state current	kA	21.0 24.0	$T_j = T_{j \max}$ $T_j = 25^\circ C$	180° half-sine wave; $t_p = 10$ ms; single pulse; $V_D = V_R = 0$ V; Gate pulse: $I_G = I_{FGM}$; $V_G = 20$ V; $t_{GP} = 50$ μs ; $di_G/dt = 1$ A/ μs
			22.0 25.0	$T_j = T_{j \max}$ $T_j = 25^\circ C$	180° half-sine wave; $t_p = 8.3$ ms; single pulse; $V_D = V_R = 0$ V; Gate pulse: $I_G = I_{FGM}$; $V_G = 20$ V; $t_{GP} = 50$ μs ; $di_G/dt = 1$ A/ μs
I^2t	Safety factor	$A^2 \cdot 10^3$	2200 2800	$T_j = T_{j \max}$ $T_j = 25^\circ C$	180° half-sine wave; $t_p = 10$ ms; single pulse; $V_D = V_R = 0$ V; Gate pulse: $I_G = I_{FGM}$; $V_G = 20$ V; $t_{GP} = 50$ μs ; $di_G/dt = 1$ A/ μs
			2000 2500	$T_j = T_{j \max}$ $T_j = 25^\circ C$	180° half-sine wave; $t_p = 8.3$ ms; single pulse; $V_D = V_R = 0$ V; Gate pulse: $I_G = I_{FGM}$; $V_G = 20$ V; $t_{GP} = 50$ μs ; $di_G/dt = 1$ A/ μs
BLOCKING					
V_{DRM}, V_{RRM}	Repetitive peak off-state and Repetitive peak reverse voltages	V	2000...2800	$T_{j \min} < T_j < T_{j \max}$; 180° half-sine wave; 50 Hz; Gate open	
V_{DSM}, V_{RSM}	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	2100...2900	$T_{j \min} < T_j < T_{j \max}$; 180° half-sine wave; single pulse; Gate open	
V_D, V_R	Direct off-state and Direct reverse voltages	V	$0.6 \cdot V_{DRM}$ $0.6 \cdot V_{RRM}$	$T_j = T_{j \max}$; Gate open	

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TRIGGERING				
I_{FGM}	Peak forward gate current	A	8	$T_j = T_{j\max}$
V_{RGM}	Peak reverse gate voltage	V	5	
P_G	Gate power dissipation	W	8	$T_j = T_{j\max}$ for DC gate current
SWITCHING				
$(di_T/dt)_{crit}$	Critical rate of rise of on-state current non-repetitive ($f=1$ Hz)	A/ μ s	2200	$T_j = T_{j\max}; V_D = 0.67 \cdot V_{DRM}; I_{TM} = 7700$ A; Gate pulse: $I_G = 2$ A; $V_G = 20$ V; $t_{GP} = 50$ μ s; $di_G/dt = 2$ A/ μ s
THERMAL				
T_{stg}	Storage temperature	°C	-60...+50	
T_j	Operating junction temperature	°C	-60...+125	
MECHANICAL				
F	Mounting force	kN	24.0...28.0	
a	Acceleration	m/s ²	50	Device clamped

CHARACTERISTICS

Symbols and parameters		Units	Values	Conditions		
ON-STATE						
V_{TM}	Peak on-state voltage, max	V	2.40	$T_j = 25$ °C; $I_{TM} = 3140$ A		
$V_{T(TO)}$	On-state threshold voltage, max	V	1.408	$T_j = T_{j\max};$		
r_T	On-state slope resistance, max	$m\Omega$	0.360	$0.5 \pi I_{TAV} < I_T < 1.5 \pi I_{TAV}$		
I_H	Holding current, max	mA	500	$T_j = 25$ °C; $V_D = 12$ V; Gate open		
BLOCKING						
I_{DRM}, I_{RRM}	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	150	$T_j = T_{j\max};$ $V_D = V_{DRM}; V_R = V_{RRM}$		
$(dv_D/dt)_{crit}$	Critical rate of rise of off-state voltage ¹⁾ , min	V/ μ s	200, 320, 500, 1000, 1600, 2000, 2500	$T_j = T_{j\max};$ $V_D = 0.67 \cdot V_{DRM};$ Gate open		
TRIGGERING						
V_{GT}	Gate trigger direct voltage, max	V	3.00 2.50 1.50	$T_j = T_{j\min}$ $T_j = 25$ °C $T_j = T_{j\max}$	$V_D = 12$ V; $I_D = 3$ A; Direct gate current	
I_{GT}	Gate trigger direct current, max	mA	500 300 150	$T_j = T_{j\min}$ $T_j = 25$ °C $T_j = T_{j\max}$		
V_{GD}	Gate non-trigger direct voltage, min	V	0.45	$T_j = T_{j\max}; V_D = 0.67 \cdot V_{DRM};$		
I_{GD}	Gate non-trigger direct current, min	mA	70.00	Direct gate current		
SWITCHING						
t_{gd}	Delay time, max	μ s	0.85	$T_j = 25$ °C; $V_D = 1500$ V; $I_{TM} = I_{TAV};$ $di/dt = 200$ A/ μ s;		
t_{gt}	Turn-on time ²⁾ , max	μ s	2.00, 2.50, 3.20, 4.00	Gate pulse: $I_G = 2$ A; $V_G = 20$ V; $t_{GP} = 50$ μ s; $di_G/dt = 2$ A/ μ s		
t_q	Turn-off time ³⁾ max	μ s	50.0, 63.0	$dv_D/dt = 50$ V/ μ s;	$T_j = T_{j\max};$ $I_{TM} = I_{TAV};$ $di_R/dt = -10$ A/ μ s; $V_R = 100$ V; $V_D = 0.67 \cdot V_{DRM}$	
			63.0, 80.0	$dv_D/dt = 200$ V/ μ s;		
Q_{rr}	Total recovered charge, max	μ C	1000	$T_j = T_{j\max}; I_{TM} = I_{TAV};$ $di_R/dt = -50$ A/ μ s;		
t_{rr}	Reverse recovery time, max	μ s	8.7	$V_R = 100$ V		
I_{rrM}	Peak reverse recovery current, max	A	230			

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THERMAL					
R_{thjc}	Thermal resistance, junction to case, max	$^{\circ}\text{C}/\text{W}$	0.0200	Direct current	Double side cooled
R_{thjc-A}			0.0440		Anode side cooled
R_{thjc-K}			0.0360		Cathode side cooled
R_{thck}	Thermal resistance, case to heatsink, max	$^{\circ}\text{C}/\text{W}$	0.0040	Direct current	
MECHANICAL					
w	Weight, max	g	510		
D_s	Surface creepage distance	mm (inch)	31.60 (1.244)		
D_a	Air strike distance	mm (inch)	16.50 (0.649)		

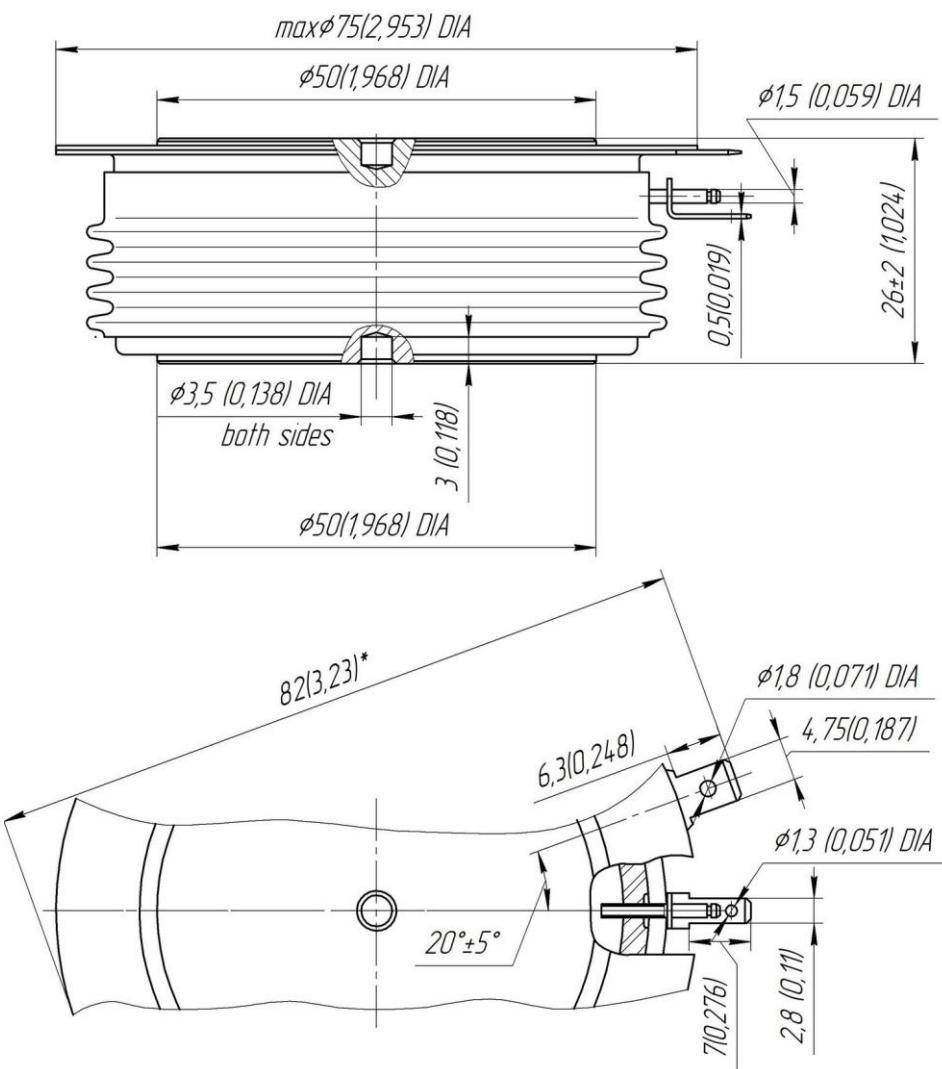
PART NUMBERING GUIDE							NOTES																							
FDT	56	1000	28	7	1	4																								
1	2	3	4	5	6	7																								
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2. Design version																														
3. Mean on-state current, A																														
4. Voltage code																														
5. Critical rate of rise of off-state voltage																														
6. Group of turn-off time ($\text{dv}_D/\text{dt}=50 \text{ V}/\mu\text{s}$)																														
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OVERALL DIMENSIONS

Package type: T.D5



All dimensions in millimeters (inches)